

深圳市索瑞达电子有限公司

承 认 书 SPECIFICATION FOR APPROVAL

客户名称: Customer Name:	EDSG0268	
客户料号: Customer P/N:		
产 品 名 称: Product Name:	功率电感	
索 瑞 达 料 号: Sorede P/N:	SCD.5845.DYF221KT00	





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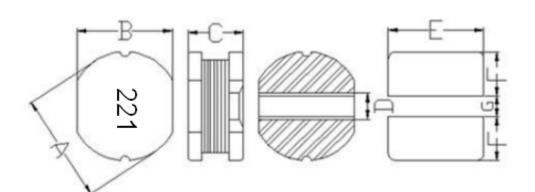
修改履历表

Modify Resume

	Widely Resume	
修改日期	修改明细	修改后版本号
Date modified	Modify Details	Version No.
		version no.
2020-12-07	文件新制订 File formulation	A
		+

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1、外形尺寸 Dimension:



单位Unit: mm

A	5.8±0.3
В	5.2±0.3
C	4.5±0.3
D	1.6Ref.
Е	5.8Ref.
F	2.2Ref.
G	1.6Ref.

2、产品品名构成 Product Spec. Model

<u>SCD</u>. <u>5845</u>. <u>D</u> <u>Y</u> <u>F</u> <u>221</u> <u>K</u> <u>T</u> <u>00</u> a b c d e f g h i

- a: 系列名称Series name
- b: 产品尺寸Product dimensions (AxBxC)
- C: 绕组(D:单线Single Line、C: 双线Double Line)
- d: 密封方式Sealing way (L: 冷封Cold seal Y: 热封Heat seal)
- e: 印字方向 Lettering direction ▶
- f: 电感值Inductance Value

(1R0:1.0uH; 100: 10uH; 101:100uH)

- g: 电感公差Inductance Tolerance (K:10%; M:20%; N:30%)
- h: 包装Package(T:磁带/卷轴Tape/Reel、B: 散装Bulk)
- i: 编号Numbering (标准standard)

3、结构Structure

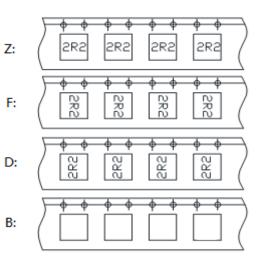


4、材料清单MATERIAL LIST

NO.	PARTS	MATERIAL SPECIFICATIONS	UL FILE NO.	TEMP. CLASS
1	CORE	R4N DR5.8*4.5R B2.2-2.4+M OR EQUIVALENT	NA	NA
2	WIRE	G1 P180 OR EQUIVALENT	E258243	180℃
3	SOLDER	Sn99.3-Cu0.7 OR EQUIVALENT	NA	NA

^{*}NA:NOT APPLICABLE.

Lettering direction



文件编号 File Number 5、电性能参数	SRD-W	I-12804	15万 プ	L 			
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	表 Electi	rical Char	acteristics Lis	st			
规格型号 Part NO.		电感量 erance(μH)	测试频率 Test Freq. (kHz/v)	直流电阻 DCR Max (Ω)	饱和电流 Isat (A)	线径WIRE (φ/mm)	圈数TS (Ref)
SCD.5845.DYF221	KT00	220	100 / 0.25	1.45	0.35	0.15	90.5

Isat电流:指使电感量比初始值下降10%Max (The rated DC current is that which cause at 10%Max inductance reduction from the initial value)。

[※]公差Tolerance: N:±30%、M:±20%、K:±10%.

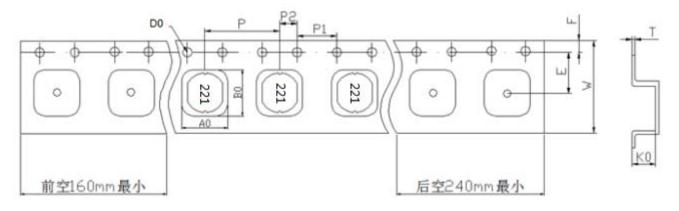
[※]工作温度Operating temperature rang: -40 $^{\circ}$ to +125 $^{\circ}$ (Including Self-heating)

[※]储存温度Storage termperature rang: -40 $^{\circ}$ to +125 $^{\circ}$

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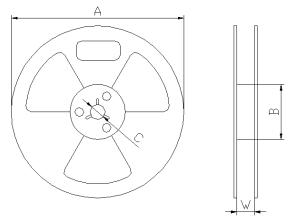
6、产品包装 Packaging

1) 载带包装示意图 Tape packing diagram



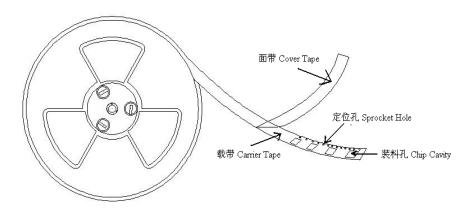
ITEM	W	A0	В0	K0	P	Е	F	D0	Р0	P2	T
DIM	12.00	5.40	5.90	4.80	8.00	5.50	1.75	1.50	4.00	2.00	0.40
TOLE	±0.3	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	+0.1	±0.1	±0.1	±0.05

2)卷盘包装示意图 Tape packing diagram



Α	330±0.5
В	100±0.5
С	13.5±0.5
W	12.5±0.5

3) 卷盘包装示意图 Tape packing diagram

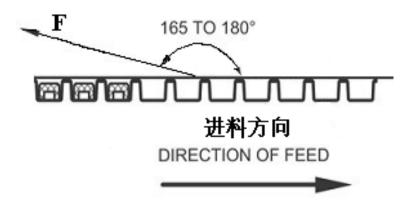


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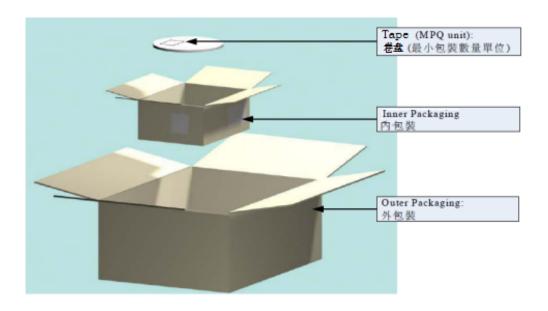
4) 剥离强度要求Peeling required

①F 力大小: 20~100g;

②面带剥离角度: 165°~180°。



5) 包装数量 Packing quantity



项目 (Project)	数量(PCS)	尺寸规格(Size:mm)
盘(Reel)	1500	13"
内盒 (Inner box)	6000	340mm*340mm*65mm
外箱 (Out box)	18000	360mm*360mm*225mm

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7. RELIABILITY TEST METHOD MECHANICAL TEST ITEM **SPECIFICATION** TEST DETAILS Substrate bendir △L/Lo≦±5% The sample shall be soldered onto the printed circuit board in figure 1 and a load applied unitil the figure in the arrow There shall be direction is made approximately 3mm.(keep time 30 seconds) no mechanical PCB dimension shall the page 7/9 damage or elec-F(Pressurization) trical damege. 45±2 45±2 PRESSURE ROD figure-1 R340 Vibration △L/Lo≦±5% The sample shall be soldered onto the printed circuit board and when a vibration having an amplitude of 1.52mm There shall be and a frequency of from 10 to 55Hz/1 minute repeated should no mechanical be applied to the 3 directions (X,Y,Z) for 2 hours each. damage. (A total of 6 hours) New solder Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated Solderability More than 90% over the whole of the sample before hard, the sample shall then be preheated for about 2 minutes in a temperature of $130\sim150^{\circ}\text{C}$ and after it has been immersed to a depth 0.5mm below for 3±0.2 seconds fully in molten solder M705 with a temperature of 245±2°C. More than 90% of the electrode sections shall be couered with new solder smoothly when the sample is taken out of the solder bath.

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MECHANICAL									
TEST ITEM		SPECIF	ICATION						
Resistance to	There shall be	Il be Temperature profile of reflow soldering							
Soldering heat	no damage or								
(reflow soldering)	problems.	The specimen shall be produced to the specimen shall be specimen shall specimen specimen shall specimen specime	Pre-heating 2 min Dassed through the above profile for 1 stored at standard	(Stortempe 2 min. o	the				
ELECTRICAL									
TEST ITEM	SPECIFICATION		TEST DETA	ILS					
Insulation	There shall be no other damage or problems.	DC 100V voltage shall b	e applied across	this sample of top					
resistance	damage of problems.	surface and the terminal	l.						
		The insulation resistance shall be more than 1 × $10^8 \Omega$.							
Dielectric	There shall be	AC 100V voltage shall b	e applied for 1 mi	inute acrosset the	top				
withstand	no other	surface and the terminal	l of this sample						
voltage	damage or								
	problems.								
Temperature	△L/L20°C ≦±10%	The test shall be perform	ned after the sam	ple has stabilized	in				
characteristics	0~2000 ppm/°C	an ambient temperature of - 40 to + 125℃ ,and the value							
		calculated based on the	value applicable	in a normal					
		temperature and narmal	humidity shall be	e △L/L 20°C ≦± 10)%.				

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ENVIROMENT	CHARACTERISTICS	 S									
TEST ITEM	SPECIFICATION										
High temperature	△L/Lo≦±5%	The sample shall be left for 500hours in an atmospere with									
storage		a temperature of 125±2℃ and a normal humidity.									
	There shall be	Upon con	Upon completion of the measurement shall be made after the								
	no mechanical	sample h	sample has been left in a normal temperature and normal								
	damage.	humidity for 1 hour.									
Low temperature	△L/Lo≦±5%	The samp	ole sh	all be left for 500 hours	in an atmosphere with						
storage		a temperature of -40±3℃.									
	There shall be	Upon con	npletio	on of the test, the meas	urement shall be made						
	no mechanical	after the	sampl	e has been left in a nor	mal temperature and						
	damage.	normal hu	umidit	y for 1 hour.							
Change of	△L/Lo≦±5%	The sample shall be subject to 5 continuos cycles, such as shown									
temperature		in the table 2 below and then it shall be subjected to standard									
	There shall be	stmosphe	stmospheric conditions for 1 hour, after which measurement								
	no other dama-	shall be made.									
	ge of problems										
		table 2									
				Temperature	Duration						
			1	-40 ±3 ℃	10 min.						
				(Themostat No.1)							
			2	Standard	5 sec. or less						
				atmospheric	No.1→No.2						
			3	125±2℃	30 min.						
				(Themostat No.2)							
			4	Standard	5 sec. or less						
				atmospheric	No.2→No.1						
Moisuture storage	△L/Lo≦±5%	The samp	ole sh	all be left for 500 hours	in a temperature of						
		40±2°C a	nd a h	numidity(RH) of 90 \sim 95 $^{\circ}$	%.						
	There shall be	Upon con	npletio	on of the test, the meas	urement shall be made						
	no mechanical	after the sample has been left in a normal temperature and									
	damage.	normal hu	umidit	y more than 1 hour.							

Test conditions:

The sample shall be reflow soldered onto the printed circuit board in every test.

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8、测试数据									
CUSTOMER		EDSG0268		Q	QUANTITY 5PCS		S		
OESCRIPTION		SCD. 5845. DYF221KT00			DATE	2020/12/7			
ITEM	LOA	(uH)	0.35A (uH)	DCR(Ω)	R(Ω) Di		imension		
SPEC	220uH±10%		≥0A×90%	1.45 Max.		A (mm)		B (mm)	C (mm)
		/0.25V	1.45 Max.		5.8 ± 0.3		5. 2 ± 0.3	4.5 ± 0.3	
1	215		208	1.02		5. 83		5. 22	4. 52
2	22	20	213	1.00		5.82		5. 24	4. 54
3	219		214	1.01		5. 84		5. 23	4. 55
4	2:	23	210	1.03		5. 83		5. 25	4. 53
5	2	18	215	1.02		5. 85		5. 23	4. 54
Average	219	219. 00 212. 00		1.02		5. 83		7. 09	4. 54
R	8.	00	7. 00	0.03		0.03		0. 03	0. 03

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9、注意事项 Note

①本承认书保证我司产品作为一个单体时的质量情况。当我司产品被安装到贵司产品上时,请保证 贵司的产品已根据贵司的规范进行了有效评估和确认。

This product specification guarantees the quality of our product as a single unit. Please make sure that your product is evaluated and confirmed against your specifications when our product is mounted to your product.

②如果贵司对我司产品的使用已超过了本承认书所界定的产品功能,那么对于由此引发的失效, 我司将不予保证。

We cannot warrant against failure caused by any use of our product that deviates from the intended use as described in this product specification.

- ③为了保持终端电极的焊接性,并使包装材料保持良好状态,必须控制储存区的温度和湿度。
 To maintain the solderabilty of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled.
 - ※建议的条件: -10~+40℃, 30~70%RH。

Recommended conditions: -10 \sim +40 $^{\circ}$ C, 30 \sim 70%RH.

※储存超过六个月的,应在实际使用前进行焊接检验。
In case of storage over 6 months, soldrability shall be checked before actual usage.

※即使在理想的储存条件下,产品的可焊性也随着时间的推移而降低。因此,产品应从交货时算起, 建议8个月之内使用完。

Even under ideal storage conditions, the weldability of the product decreases over time. therefore, the product should be From the time of delivery, it is recommended that it be used within 8 months.

④本承认书在客户收到30天之内,必须签章返回,逾期视为默认。

The Specification Approval should be sent back to the supplier with customer's chop on it within 30 days after receiving it, or we will take it as approved by customer's automatically.

⑤如有特殊规格要求,请事前联络我司技术部人员。

In case of special specifications please contact our technical department prior staff.